

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Appl. for Reissue No. : 09/714,680  
Patent No. : 6,054,198  
Applicant : Bunyan *et al.*  
Filed : November 16, 2000  
Title : Conformal Thermal Interface  
Material For Electronic Components

TC/A.U. : 1773  
Examiner : S. Ahmed

Docket No. : 2802-257-006

Honorable Commissioner For Patents  
Alexandria, VA 22313-1450

**AMENDMENT**

In response to the Office action of April 23, 2009, reconsideration of the above-identified application as amended is respectfully requested:

**Remarks** begin on page 2 of this paper.

Attachments: **Consent of Assignee**  
**Statement Under 37 CFR §3.73(b)**  
**Supplemental Declaration**